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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
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JI YEON KWAK	08/19/2013
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Property Type	Number
Application Number:	29465041

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Total Attachments: 2

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PATENT REEL: 031647 FRAME: 0312 OF \$40.00 29465041

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

DECLARATION

As a below-named inventor	r, I hereby declare that t	his declaration is directed to the application attached hereto, o
		ational Application Number
filed on		
	ELEC	TRONIC DEVICE
The above-identified applica	ation was made or auth	orized to be made by me.
I believe I am the original in application.	ventor or an original joi	nt inventor of a claimed invention in the above-identified
I hereby acknowledge that a by fine or imprisonment of n	any willful false stateme not more than five (5) ye	ent made in this declaration is punishable under 18 USC 1001 pars, or both.
I have reviewed and unders	stand the contents of the	above-identified application, including the claims.
to be material to patentabilit	ty as defined in 37 CFR ailable between the filin	ites Patent and Trademark Office all information known to me 1.56, including for continuation-in-part applications, material g date of the prior application and the national or PCT pplication.
	A	SSIGNMENT
For valuable consideration,	I, as a below-named as	signor, hereby assign to:
Samsung Electronic 129, Samsung-ro, Y Suwon-si, Gyeongg Republic of Korea	eongtong-gu	
and its successors and assi	gns (collectively hereina	after called "the Assignee"), the entire right, title, and interest
		nents that are the subject of the application identified in the
	United States Application	on Number or PCT International Application Number
		he above-identified application to bereafter complete this

Assignment by inserting above the application number and the filing date of the above-identified application when known, and to correct any typographical errors that may be discovered in this Assignment.

This Assignment includes the above-identified application, any and all United States and foreign patents, utility models, and design registrations granted for any of the inventions and improvements that are the subject of the above-identified application, and the right to claim priority based on the filling date of the above-identified application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further

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COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

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